



Ferrites and accessories

EELP 58, EILP 58
Core set (without clamp recess)

Series/Type: B66293G, B66293P
Date: September 2006

ELP 58/11/38

Core (without clamp recess)

B66293

Core set EELP 58

Combination: ELP 58/11/38 with ELP 58/11/38

- To IEC 62317-9
- Delivery mode: single units

Magnetic characteristics (per set)

$$\Sigma l/A = 0.26 \text{ mm}^{-1}$$

$$l_e = 80.7 \text{ mm}$$

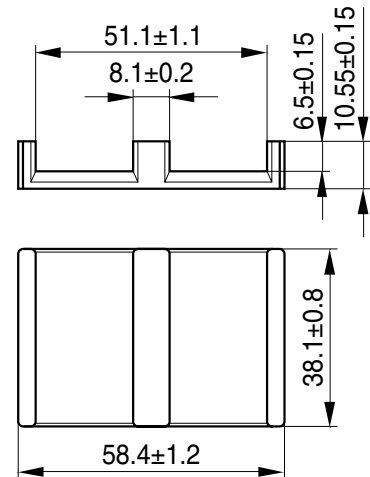
$$A_e = 310 \text{ mm}^2$$

$$A_{\min} = 308 \text{ mm}^2$$

$$V_e = 25000 \text{ mm}^3$$

Approx. weight 130 g/set

ELP 58/11/38



FEK0410-E

Ungapped

Material	A_L value nH	μ_e	P_V W/set	Ordering code (per piece)
N87	$7400 \pm 25\%$	1540	< 15.0 (200 mT, 100 kHz, 100 °C)	B66293G0000X187

Calculation factors (for formulas, see “E cores: general information”)

EELP 58:

Material	Relationship between air gap – A_L value		Calculation of saturation current			
	K1 (25 °C)	K2 (25 °C)	K3 (25 °C)	K4 (25 °C)	K3 (100 °C)	K4 (100 °C)
N87	521	−0.732	763	−0.796	705	−0.873

Validity range: K1, K2: $0.10 \text{ mm} < s < 1.50 \text{ mm}$
K3, K4: $50 \text{ nH} < A_L < 500 \text{ nH}$

ELP 58/11/38 with I 58/4/38

Core (without clamp recess)

B66293

Core set EILP 58

Combination:

ELP 58/11/38 with I 58/4/38

- To IEC 62317-9
- Delivery mode: single units

Magnetic characteristics (per set)

$$\Sigma l/A = 0.22 \text{ mm}^{-1}$$

$$l_e = 67.7 \text{ mm}$$

$$A_e = 310 \text{ mm}^2$$

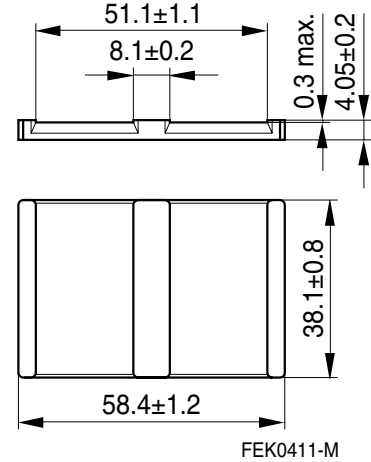
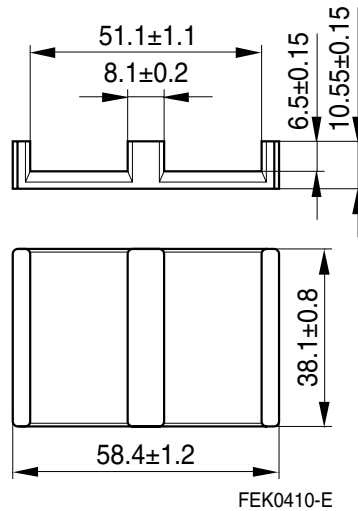
$$A_{\min} = 308 \text{ mm}^2$$

$$V_e = 21000 \text{ mm}^3$$

Approx. weight 110 g/set

ELP 58/11/38

I 58/4/38



Ungapped

Material	A_L value nH	μ_e	P_V W/set	Ordering code (per piece)
N87	8400 $\pm 25\%$	1450	< 13.0 (200 mT, 100 kHz, 100 °C)	B66293G0000X187 (ELP core) B66293P0000X187 (I core)

Calculation factors (for formulas, see “E cores: general information”)

EILP 58:

Material	Relationship between air gap – A_L value		Calculation of saturation current			
	K1 (25 °C)	K2 (25 °C)	K3 (25 °C)	K4 (25 °C)	K3 (100 °C)	K4 (100 °C)
N87	591	−0.685	791	−0.796	721	−0.873

Validity range: K1, K2: 0.10 mm < s < 1.50 mm
K3, K4: 50 nH < A_L < 500 nH

Ferrites and accessories

Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see Data Book 2007, chapter "General – Definitions, 8.1".

Effects of core combination on A_L value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see Data Book 2007, chapter "General – Definitions, 8.2".

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Processing notes

- The start of the winding process should be soft. Else the flanges may be destroyed.
- To strong winding forces may blast the flanges or squeeze the tube that the cores can no more be mount.
- To long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyd of the tin bath or burned insulation of the wire. For detailed information see Data Book 2007, chapter "Processing notes, 2.2".
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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